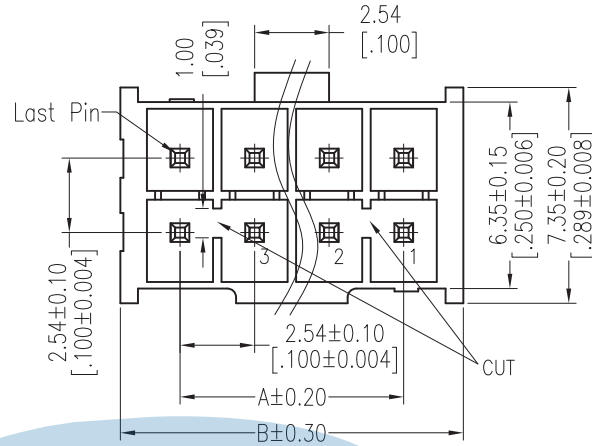


NOTES:
 Rated Current:3.0AMP
 Contact Resistance:20mΩ max
 Withstand Voltage:1000V AC/DC
 Insulation Resistance:1000MΩ min
 Operation Temperature:-55°C to +125°C

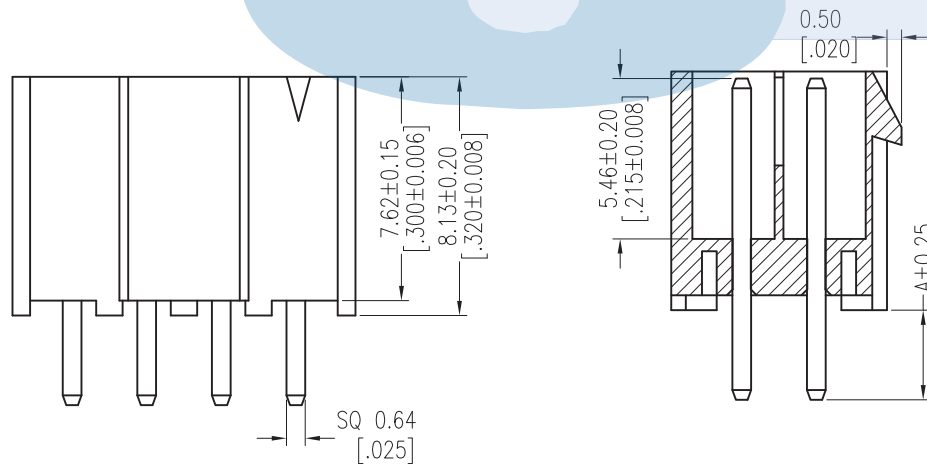
Contact Material:Brass
 Contact plating:Au Or Sn Over Ni
 Insulator Material:LCP+30%G.F (UL94V-0)



DIMENSIONS:

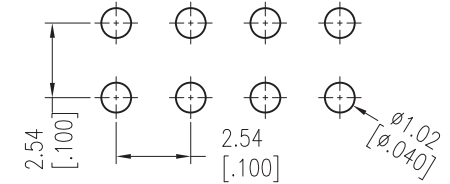
A = 2.54x (XX/2-1)

B = 2.54x (XX/2)+1.52



ITEM	A
Standard	3.05
Alternate	

Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



Ordering Information:

5781- T- XX- 1

1 2 3

1. Connector Series

2. (T) Contact Plating

- T = 2. Tin plated
- T = 3. Gold flash over nickel
Recommended Finish
- T = 5. 15μ" gold over nickel
- T = 6. 30μ" gold over nickel

3. (XX) Number of circuits

- Available in 4 through 50 circuits

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION		DRAW Tang	DATE 2012/11/06	SCALE UNIT	FIT mm inch	PART NO. SEE TAB
				X.X	±0.40					
				X.XX	±0.25	CHECK	DATE	SIZE A4		TITLE: 2.54mm WAFER 180° DIP WITH CUT
AO	2012/11/06	NEW		X.XXX	±0.15	APPROVE	DATE	SHEET 1/1		Customer NO.
				Angle DIM	± 3' TOL			PROJ.		



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